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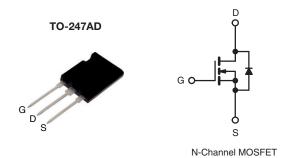
HALOGEN

FREE

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# **E Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 \text{ V}$	0.067		
Q <sub>g</sub> max. (nC)	225			
Q <sub>gs</sub> (nC)	31			
Q <sub>gd</sub> (nC)	63			
Configuration	Single			



### **FEATURES**

- Fast Body Diode MOSFET Using E Series Technoloy
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- Low switching losses due to reduced Q<sub>rr</sub>
- Ultra Low Gate Charge (Qq)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Telecommunications
  - Server and Telecom Power Supplies
- Lighting
- High-Intensity Lighting (HID)
- Light Emitting Diodes (LEDs)
- Consumer and Computing
  - ATX Power Supplies
- Industrial
  - Welding
- Battery Chargers
- · Renewable Energy
  - Solar (PV Inverters)
- Switching Mode Power Supplies (SMPS)
- Applications using the following topologies
  - LLC
  - Phase Shifted Bridge (ZVS)
  - 3-level Inverter
  - AC/DC Bridge

ORDERING INFORMATION		
Package	TO-247AD	
Lead (Pb)-free and Halogen-free	SiHW47N60EF-GE3	

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage Gate-Source Voltage	V <sub>DS</sub>	600	V			
Gate-Source Voltage	V <sub>GS</sub>	± 20				
Gate-Source Voltage AC (f > 1 Hz)		30				
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $\frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	I <sub>D</sub>	47	А		
	$V_{GS}$ at 10 $V_{C}$ $T_{C} = 100 ^{\circ}C$		29			
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	138				
Linear Derating Factor		3	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	1500	mJ			
Maximum Power Dissipation	$P_{D}$	379	W			
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	ط/\//ط÷	37	V/ns		
Reverse Diode dV/dt <sup>d</sup>		dV/dt	9.7	V/IIS		
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s		300	°C		

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 73.5 \,^{\circ}\text{mH}$ ,  $R_q = 25 \,^{\circ}\Omega$ ,  $I_{AS} = 6.4 \,^{\circ}\text{A}$ .
- c. 1.6 mm from case.

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d.  $I_{SD} \le I_D$ , dI/dt = 100 A/ $\mu$ s, starting  $T_J = 25$  °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40	°C/W	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	0.33	C/VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static				-	-		•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I <sub>D</sub> = 1 mA			-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
-		V <sub>DS</sub> =	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 24 A	-	0.056	0.067	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> = 24 A	-	17	-	S
Dynamic				l	1		
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		-	4854	-	-
Output Capacitance	C <sub>oss</sub>			-	195	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	6	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	208	-	pF
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	651	-	
Total Gate Charge	Qg			-	150	225	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 24 A, V_{DS} = 480 V$	-	31	-	nC
Gate-Drain Charge	$Q_{gd}$			-	63	-	
Turn-On Delay Time	$t_{d(on)}$	·		-	30	60	- ns
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 24 A,		61	92	
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS} = 10 \text{ V}, R_g = 4.4 \Omega$		-	94	141	
Fall Time	t <sub>f</sub>			-	58	87	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.67	-	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	138	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 24 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 24 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	168	336	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.2	2.4	μC
Reverse Recovery Current	I <sub>RRM</sub>			_	14	_	A

## Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

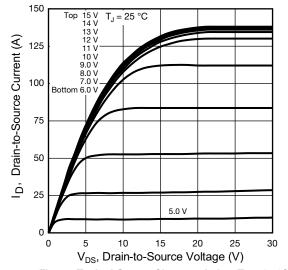


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

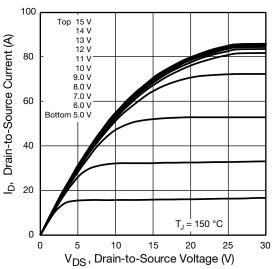


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

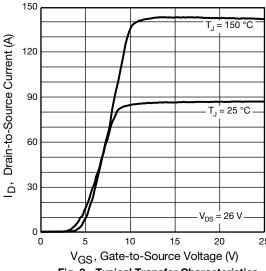


Fig. 3 - Typical Transfer Characteristics

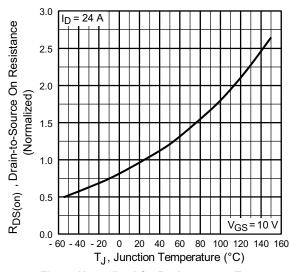


Fig. 4 - Normalized On-Resistance vs. Temperature

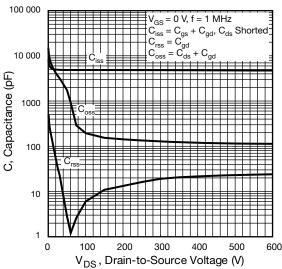


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

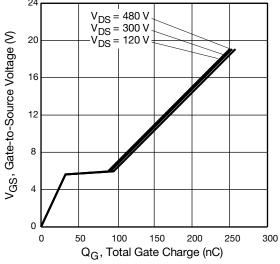


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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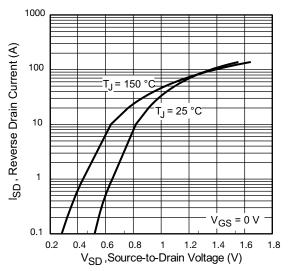


Fig. 7 - Typical Source-Drain Diode Forward Voltage

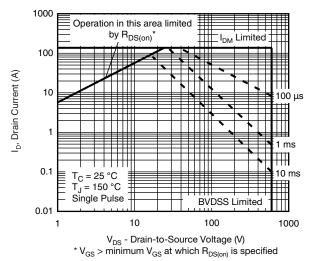


Fig. 8 - Maximum Safe Operating Area

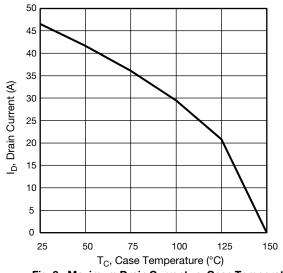


Fig. 9 - Maximum Drain Current vs. Case Temperature

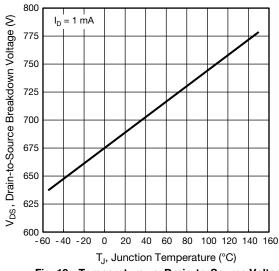


Fig. 10 - Temperature vs. Drain-to-Source Voltage

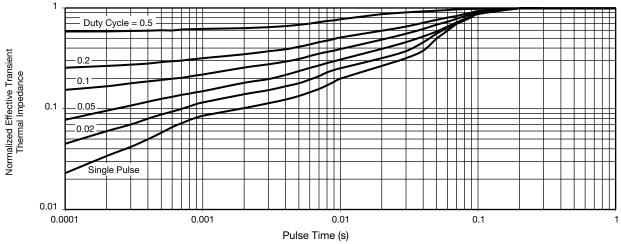


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case

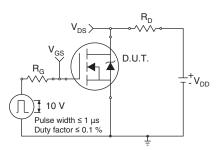


Fig. 12 - Switching Time Test Circuit

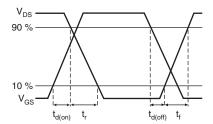


Fig. 13 - Switching Time Waveforms

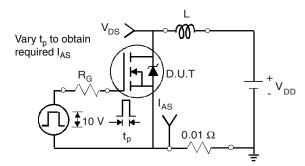


Fig. 14 - Unclamped Inductive Test Circuit

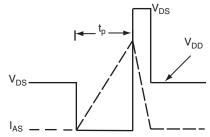


Fig. 15 - Unclamped Inductive Waveforms

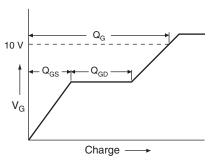


Fig. 16 - Basic Gate Charge Waveform

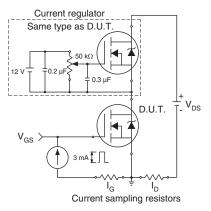
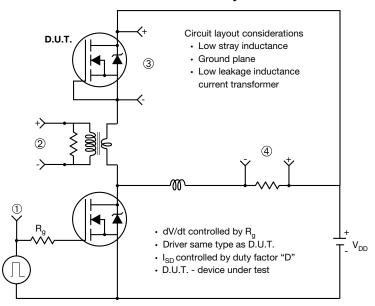


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



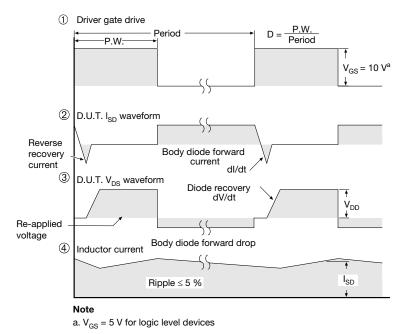


Fig. 18 - For N-Channel

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